AN6454SH

Pager Direct Conversion FSK Demodulator Mixer IC

Overview Unit : mm The AN6454SH supports direct conversion FSK demodulation for pagers, and incorporates two mixers. Features • Low current consumption : 1mA 111111 3.0±0.3 • Incorporates two mixers. 450MHz input frequency. • Small surface-mount package with 0.5mm pitch. SOP package with 10 pins (SSOP010-P-0225) Pin Descriptions Description Pin No. Pin No. Description MIX bias MIX (2) output 1 6 L-OSC input (1) 2 7 MIX (1) output L-OSC input (2) GND 8 MIX current control RF bias 9 4 Vcc 10 RF input Functional Block Diagram MIX bias RF input 10 MIX1 **| ├─**⋛ RF bias L-OSC input (1) 9 Ш L-OSC input (2) E GND 8 BIAS MIX2 ή MIX Current MIX (1) output Δ Control Vcc MIX (2) output 5

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Parameter	Syn	nbol	Ratin	ıg		ι	Jnit
Supply voltage	v	сс	4				V
Supply current	Ic	C	20			1	nA
Power dissipation	P	D	143.5 (Ta	=75°C)		n	ηW
Operating ambient temperature	T	opr	-20 to -	+ 70			°C
Storage temperature	Т	stg	-55 to +	-125			°C
Vote) Protect pins 3, 9, and 10 from e Recommented Operating Ra Parameter Operating supply voltage range				Range 1.8 to 3V			
Electrical Characteristics (V _C	_{cc} =2.0V, Ta=2	5±2°C)				J	
Parameter	Symbol		Condition	min	typ	max	Uni
Current consumption	Itot			0.6	1.0	1,4	m
MIX output level (1)		Turnet	1 54 10 6 450 0045 511	20	24	-30	dI
min output level (1)	VMIX1	Input L	evel –54dBm, f=450.0045MHz	-38	-34	A30	u
MIX output level (1) MIX output level (2) Electrical Characteristics (De The following are design value	VMIX1 sign Values fo	Input L	evel-54dBm, f=450.0045MHz rence) (V _{CC} =2.0V, Ta	-38	-34	1-30 1-30 + 11	
MIX output level (2) Electrical Characteristics (De The following are design valu Parameter	VMIX1 sign Values fo ues for reference Symbol	Input L	evel-54dBm, f=450.0045MHz rence) (V _{CC} =2.0V, Ta	-38	-34	<u>()</u>	dI Uni
MIX output level (2) Electrical Characteristics (De The following are design valu Parameter RF bias voltage	VMIX1 sign Values fo ues for reference Symbol VRF	Input L	evel_54dBm, f=450.0045MHz rence) (V _{CC} =2.0V, Ta (not guaranteed)	=25±2°C	-34	-30 + hth	dł Uni
MIX output level (2) Electrical Characteristics (De The following are design valu Parameter RF bias voltage MIX bias current	VMIX1 sign Values fo jes for reference Symbol VRF VMIX	Input L or Refer ce only	evel_54dBm, f=450.0045MHz rence) (V _{CC} =2.0V, Ta (not guaranteed) Condition	=25±2°C	-34	-30 -30 	dI
MIX output level (2) Electrical Characteristics (De The following are design valu Parameter RF bias voltage MIX bias current MIX output level difference	VMIX1 sign Values fo les for reference Symbol VRF VMIX DVmix	Input L or Refer ce only	evel_54dBm, f=450.0045MHz rence) (V _{CC} =2.0V, Ta (not guaranteed) Condition	=25±2°C	-34	-30 + hth	dI
MIX output level (2) Electrical Characteristics (De The following are design valu Parameter RF bias voltage MIX bias current MIX output level difference	VMIX1 sign Values fo les for reference Symbol VRF VMIX DVmix	Input L or Refer ce only	evel-54dBm, f=450.0045MHz rence) (V _{CC} =2.0V, Ta (not guaranteed) Condition	=25±2°C	-34	-30 -30 	dI Uni d

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Pin No.	Symbol	Description	Equivalent circuit
1	MIX bias	Local oscillator bias. Normally grounded though a capacitor.	2 3 12kΩ
2	L-OSC input 1	Local oscillator inputs to Pin2 w and 3 are different in phase by $\pi/2$. These inputs are different in frequency	
3	L-OSC input 2	by FM Dev from Pin 10 input.	
4	MIX-current control	Current input to this pin controls the IC's operation and total current. This pin may be connected to Pin 22 of AN6400.	⁴ πation ⁴ πation ⁴ πation ⁴ πation ⁴ πation ⁴ πation ⁴ πation
5	Vcc		ab ^c ritc ^c
6	MIX2 output	This is the supply voltage pin.	• • • • • • • • • • • • • • • • • • •
7	MIX I output	to AN6400 or other direct conversion demodulator ICs for data retrieval.	V _{cc} ν _{cc} ν _{cc} ν _{cc} γ

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Pin No.	Symbol	Description	Equivalent circuit
8	GND	This is the ground pin.	
9	RF bias	This is the bias pin for RF input to Pin 10. The bias us internally provided. This pin must be ground through a capacitor.	
10	RF input		2κΩ m m m formation
		FSK-modulated RF signals from an RF amplifier are input to this pin RP signals with up to 450MHz are acceptable.	out latest indet.

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